



Powering the next generation of ML/AI, voice and audio applications

i.MX RT600 Family of Crossover MCUs

The i.MX RT600 family of secure and embedded crossover MCUs pairs a high-performance Cadence® Tensilica® HiFi 4 DSP core with the real-time functionality of an Arm® Cortex®-M33 core to help unlock the potential of ML/AI end nodes.

THE CROSSOVER MCU MARKET

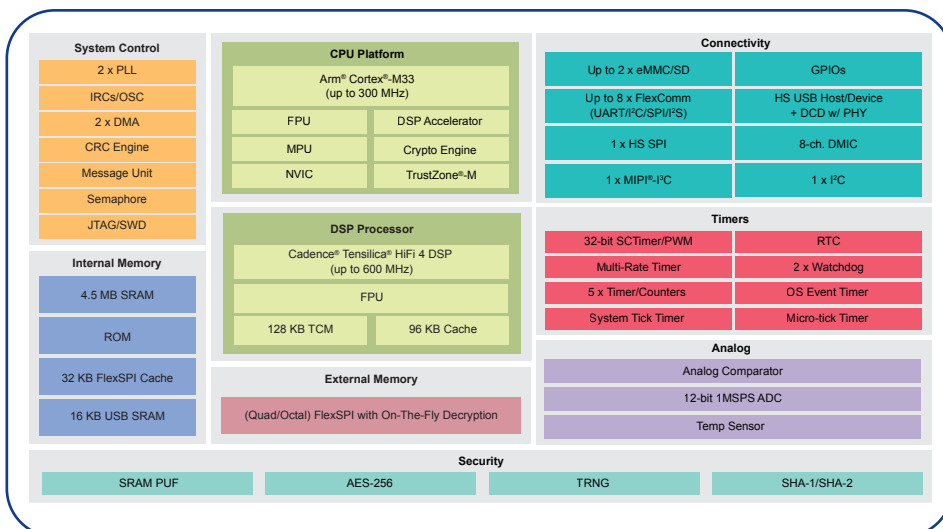
Drawing on its expertise as a leading supplier of both applications processors and microcontrollers (MCUs), NXP introduces the i.MX RT600 family, a new class of crossover MCUs that strikes balance between power optimization and high-performance capabilities.

- ▶ High performance, real-time processing
- ▶ Low power
- ▶ Rich integration
- ▶ Hardened security

TARGET APPLICATIONS

- ▶ Audio subsystem
- ▶ ML-based edge applications
- ▶ Voice recognition consumer electronics
- ▶ Voice-enabled IoT devices

i.MX RT600 CROSSOVER MCU FAMILY BLOCK DIAGRAM



PERFORMANCE HIGHLIGHTS

- ▶ Highly optimized Cadence Tensilica HiFi 4 DSP engine
 - Featuring emerging multichannel object-based audio standards
 - Ideal for DSP-intensive applications
- ▶ High-performing Arm® Cortex®-M33 core
 - Next-generation core based on the ARMv8-M architecture
 - Hardware co-processors provide accelerated support for additional DSP algorithms and cryptography
- ▶ Extensive memory resources
 - 4.5 MB SRAM accessible to both cores and both DMA engines to simplify development complexity

USABILITY HIGHLIGHTS

Design Flexibility

- ▶ Improved power efficiency
 - Wide dynamic voltage and performance range
 - Simplified power modes with fast wake-up and low leakage
 - Configurable blocks of memory for individual power gating and retention
- ▶ Advanced audio subsystem interfaces
 - DMIC interface supporting eight channels and voice activation detect
 - Up to 8 x I²S interfaces for high-performance, multichannel audio
- ▶ External memory interface options
 - Octal/Quad SPI with cache and dynamic decryption
- ▶ Numerous connectivity and communication interfaces
 - SDIO for Wi-Fi®-enabled streaming
 - High-speed USB device/host and high-speed SPI interfaces

i.MX RT600 MCU FAMILY OPTIONS

Part Number	Control Processor	DSP Processor	SRAM	Temp (Ta)	Package
MIMXRT685SFVKB	300 MHz Cortex-M33	Up to 600 MHz HiFi 4 DSP	4.5 MB	-20 to 70 °C	176 VFBGA
MIMXRT685SFFOB*	300 MHz Cortex-M33	Up to 600 MHz HiFi 4 DSP	4.5 MB	-20 to 70 °C	249 FOWLP
MIMXRT685SFAWBR*	300 MHz Cortex-M33	Up to 600 MHz HiFi 4 DSP	4.5 MB	-20 to 70 °C	114 WLCSP

* Part number coming soon

MIMXRT685-EVK



Advanced Security

- ▶ Arm TrustZone®-M for asset protection
 - System-wide, secure resource isolation for trusted hardware
- ▶ Secure boot mechanism with SRAM PUF or OTP-based unique key for hardware-based root of trust
- ▶ Symmetric and asymmetric cryptography acceleration
 - AES-256, SHA2-256
 - ECC and RSA
- ▶ Secure debug authentication

MIMXRT685-EVK | DEVELOPMENT HIGHLIGHTS

- ▶ Supports development of MIMXRT685
- ▶ Octal SPI Flash and PSRAM memories
- ▶ Audio codec with stereo line in and line out
- ▶ Dual DMICs
- ▶ DMIC expansion connector supporting up to 8 DMICs
- ▶ Micro USB supporting host or device operation
- ▶ Arduino® interface
- ▶ 10-pin and 20-pin SWD connectors
- ▶ On-board debug probe
- ▶ MCUXpresso software and tools support, including SDK with FreeRTOS
- ▶ Cadence Tensilica Xplorer tools support for HiFi 4 DSP development